

January 1996

Features

- Devices QML Qualified in Accordance with MIL-PRF-38535
- Detailed Electrical and Screening Requirements are Contained in SMD# 5962-96720 and Intersil' QM Plan
- 1.25 Micron Radiation Hardened SOS CMOS
- Total Dose >300K RAD (Si)
- Single Event Upset (SEU) Immunity: 1×10^{-10} Errors/Bit/Day (Typ)
- SEU LET Threshold >100 MEV-cm²/mg
- Dose Rate Upset >10¹¹ RAD (Si)/s, 20ns Pulse
- Dose Rate Survivability >10¹² RAD (Si)/s, 20ns Pulse
- Latch-Up Free Under Any Conditions
- Military Temperature Range -55°C to +125°C
- Significant Power Reduction Compared to ALSTTL Logic
- DC Operating Voltage Range 4.5V to 5.5V
- Input Logic Levels
 - VIL = 0.8V Max
 - VIH = VCC/2 Min
- Input Current ≤ 1μA at VOL, VOH
- Fast Propagation Delay 24ns (Max), 16ns (Typ)

Description

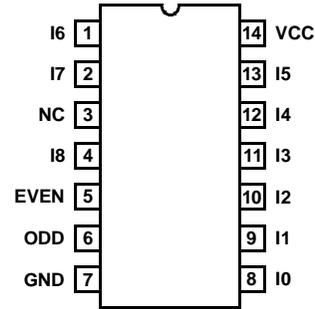
The Intersil ACTS280MS is a Radiation Hardened 9-bit odd/even parity generator checker device. Both odd and even parity outputs are available for generating or checking parity for words up to 9 bits long. Even parity is indicated (EVEN output high) when an even number of data inputs are high. Odd parity is indicated (ODD output high) when an odd number of data inputs are high. Parity checking for larger words can be accomplished by tying EVEN output to any input of an additional ACTS280MS.

The ACTS280MS utilizes advanced CMOS/SOS technology to achieve high-speed operation. This device is a member of a radiation hardened, high-speed, CMOS/SOS Logic Family.

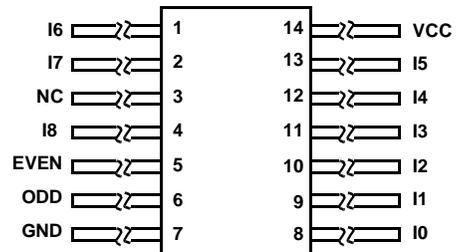
The ACTS280MS is supplied in a 14 lead Ceramic Flatpack (K suffix) or a Ceramic Dual-In-Line Package (D suffix).

Pinouts

14 PIN CERAMIC DUAL-IN-LINE
MIL-STD-1835 DESIGNATOR, CDIP2-T14,
LEAD FINISH C
TOP VIEW



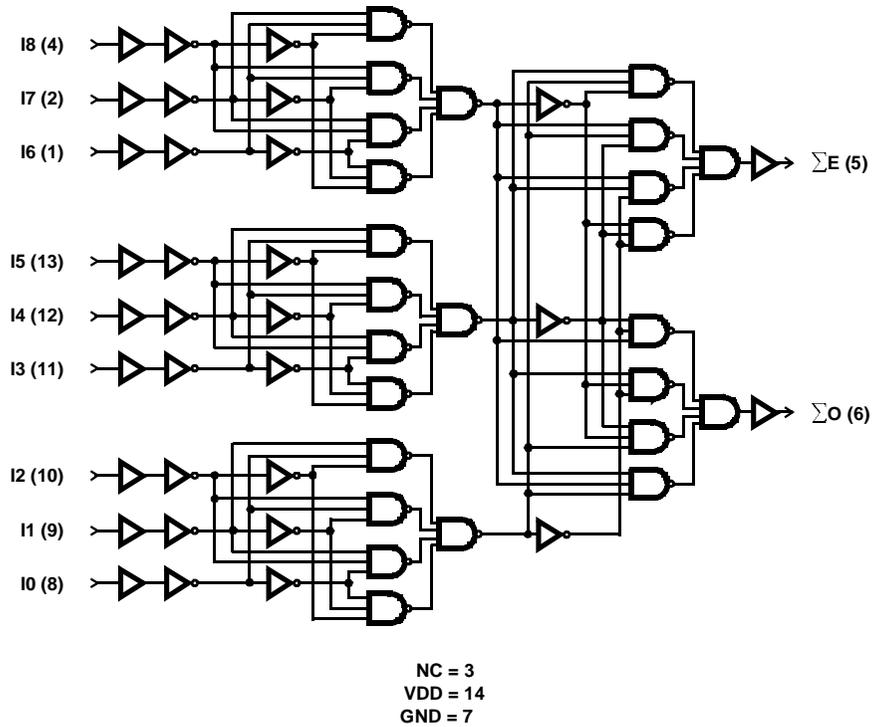
14 PIN CERAMIC FLATPACK
MIL-STD-1835 DESIGNATOR, CDFP3-F14
LEAD FINISH C
TOP VIEW



Ordering Information

PART NUMBER	TEMPERATURE RANGE	SCREENING LEVEL	PACKAGE
5962F9672001VCC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead SBDIP
5962F9672001VXC	-55°C to +125°C	MIL-PRF-38535 Class V	14 Lead Ceramic Flatpack
ACTS280D/Sample	25°C	Sample	14 Lead SBDIP
ACTS280K/Sample	25°C	Sample	14 Lead Ceramic Flatpack
ACTS280HMSR	25°C	Die	Die

Functional Diagram



All Intersil semiconductor products are manufactured, assembled and tested under **ISO9000** quality systems certification.

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ACTS280MS

Die Characteristics

DIE DIMENSIONS:

88 mils x 88 mils
2.24mm x 2.24mm

METALLIZATION:

Type: AlSi
Metal 1 Thickness: $7.125\text{k}\text{\AA} \pm 1.125\text{k}\text{\AA}$
Metal 2 Thickness: $9\text{k}\text{\AA} \pm 1\text{k}\text{\AA}$

GLASSIVATION:

Type: SiO_2
Thickness: $8\text{k}\text{\AA} \pm 1\text{k}\text{\AA}$

WORST CASE CURRENT DENSITY:

$< 2.0 \times 10^5 \text{ A/cm}^2$

BOND PAD SIZE:

$> 4.3 \text{ mils} \times 4.3 \text{ mils}$
 $> 110\mu\text{m} \times 110\mu\text{m}$

Metallization Mask Layout

